

2SP0115T2B0-FF450R12ME4 and 2SP0115T2B0C-FF450R12ME4 Data Sheet

Compact, high-performance, plug-and-play dual-channel IGBT driver based on SCALE[™]-2 technology for individual and parallel-connected modules

Abstract

The SCALETM-2 plug-and-play driver 2SP0115T2B0-FF450R12ME4 / 2SP0115T2B0C-FF450R12ME4 (Coated version using ELPEGUARD SL 1307 FLZ/2 from Lackwerke Peters with a typical thickness of 50µm) is a compact dual-channel intelligent gate driver designed for Infineon's EconoDUALTM IGBTs FF450R12ME4. The driver features an electrical interface with a built-in DC/DC power supply.

For drivers adapted to other types of high-power and high-voltage IGBT modules, refer to

www.power.com/gate-driver/go/plug-and-play

| Features | Applications |
|---|---|
| Plug-and-play solution Allows parallel connection of IGBT modules Shortens application development time Extremely reliable; long service life Built-in DC/DC power supply 20-pin flat cable interface Duty cycle 0 100% Active clamping of V_{ce} at turn-off IGBT short-circuit protection Monitoring of supply voltage Safe isolation to EN 50178 UL compliant | Wind-power converters Industrial drives UPS Power-factor correctors Traction Railroad power supplies Welding SMPS Radiology and laser technology Research and many others |
| Suitable for FF450R12ME4 | |

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Safety Notice!

The data contained in this data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 60747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

Important Product Documentation

This data sheet contains only product-specific data. For a detailed description, must-read application notes and common data that apply to the whole series, please refer to "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers" on www.power.com/gate-driver/go/2SP0115T.

When applying SCALE-2 plug-and-play drivers, please note that these drivers are specifically adapted to a particular type of IGBT module. Therefore, the type designation of SCALE-2 plug-and-play drivers also includes the type designation of the corresponding IGBT module. These drivers are not valid for IGBT modules other than those specified. Incorrect use may result in failure.

Mechanical Dimensions

Dimensions: Refer to "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers" Mounting principle: Soldered onto EconoDUAL[™] module FF450R12ME4

Absolute Maximum Ratings

| Parameter | Remarks | Min | Max | Unit |
|--|---|------|--------|----------------------|
| Supply voltage V _{CC} | VCC to GND | 0 | 16 | V |
| Logic input and output voltages | To GND | -0.5 | VCC+0. | 5 V |
| SO _x current | Fault condition, total current | | 20 | mA |
| Gate peak current Iout | Note 1 | -8 | +15 | Α |
| Average supply current I _{CC} | Note 2 | | 290 | mA |
| Output power per gate | Ambient temperature \leq 70°C (Note 3) | | 1.2 | W |
| | Ambient temperature \leq 85°C (Note 3) | | 1 | W |
| Switching frequency f | | | 19 | kHz |
| Test voltage (50Hz/1min.) | Primary to secondary (Note 16) | | 3800 | V _{AC(eff)} |
| | Secondary to secondary (Note 16) | | 3800 | VAC(eff) |
| DC-link voltage | Note 4 | | 800 | V |
| dV/dt | Rate of change of input to output voltage | | 50 | kV/µs |
| Operating voltage | Primary/secondary, secondary/secondary | | 1200 | Vpeak |



| Parameter | Remarks | Min | Max | Unit |
|-----------------------|---|-----|-----|------|
| Operating temperature | | -40 | 85 | °C |
| Storage temperature | Note 20 | -40 | 50 | °C |
| Surface temperature | Only 2SP0115T2B0C-FF450R12ME4 (Note 21) | | 125 | °C |

Recommended Operating Conditions

| Parameter | Remarks | Min | Тур | Max | Unit |
|--------------------------------|------------------------------------|------|-----|----------|------|
| Supply voltage V _{CC} | To GND | 14.5 | 15 | 15.5 | V |
| Resistance from TB to GND | Blocking time \neq 0, ext. value | 128 | | ∞ | kΩ |
| SO _x current | Fault condition, 3.3V logic | | | 4 | mA |

Electrical Characteristics

| Power Supply | Remarks | Min | Тур | Max | Unit |
|-----------------------------|--|---------|------|------|------|
| Supply current Icc | Without load | | 33 | | mA |
| Efficiency η | Internal DC/DC converter | | 85 | | % |
| Coupling capacitance Cio | Primary side to secondary side, total, per | channel | 23 | | pF |
| Power Supply Monitoring | Remarks | Min | Тур | Max | Unit |
| Supply threshold Vcc | Primary side, clear fault | 11.9 | 12.6 | 13.3 | V |
| | Primary side, set fault (Note 5) | 11.3 | 12.0 | 12.7 | V |
| Monitoring hysteresis | Primary side, set/clear fault | 0.35 | | | V |
| Supply threshold Visox-Veex | Secondary side, clear fault | 12.1 | 12.6 | 13.1 | V |
| | Secondary side, set fault (Note 6) | 11.5 | 12.0 | 12.5 | V |
| Monitoring hysteresis | Secondary side, set/clear fault | 0.35 | | | V |
| Supply threshold Veex-VCOMx | Secondary side, clear fault | 5 | 5.15 | 5.3 | V |
| | Secondary side, set fault (Note 6) | 4.7 | 4.85 | 5 | V |
| Monitoring hysteresis | Secondary side, set/clear fault | 0.15 | | | V |
| Logic Inputs and Outputs | Remarks | Min | Тур | Max | Unit |
| Input impedance | V(INx) > 3V (Note 7) | 3.5 | 4.1 | 4.6 | kΩ |
| Turn-on threshold | V(INx) (Note 8) | | 2.6 | | V |
| Turn-off threshold | V(INx) (Note 8) | | 1.3 | | V |
| SOx output voltage | Fault condition, I(SOx) < 8mA | | | 0.7 | V |



| Short-circuit Protection | Remarks | Min | Тур | Max | Unit |
|--|--|------|------|------|------------------|
| Vce-monitoring threshold | Between auxiliary terminals | | 10.2 | | V |
| Response time | DC-link voltage > 550V (Note 9) | | 5.4 | | μs |
| Delay to IGBT turn-off | After the response time (Note 10) | | 1.4 | | μs |
| Blocking time | After fault (Note 11) | | 90 | | ms |
| Timing Characteristics | Remarks | Min | Тур | Max | Unit |
| Turn-on delay t _{d(on)} | Note 12 | | 75 | | ns |
| Turn-off delay t _{d(off)} | Note 12 | | 65 | | ns |
| Jitter of turn-on delay | Note 18 | | ±2 | | ns |
| Jitter of turn-off delay | Note 18 | | ±4 | | ns |
| Output rise time tr(out) | G _x to E _x (Note 13) | | 5 | | ns |
| Output fall time t _{f(out)} | G _x to E _x (Note 13) | | 10 | | ns |
| Dead time between outputs | Half-bridge mode (Note 19) | | 3 | | μs |
| Jitter of dead time | Half-bridge mode | | ±50 | | ns |
| Transmission delay of fault state | Note 14 | | 400 | | ns |
| Outputs | Remarks | Min | Тур | Мах | Unit |
| Turn-on gate resistor R _{g(on)} | Note 15 | | 1.3 | | Ω |
| Turn-off gate resistor Rg(off) | Note 15 | | 1.8 | | Ω |
| Gate voltage at turn-on | | | 15 | | V |
| Gate-voltage at turn-off | P=0W | | -9.2 | | V |
| | P=1.2W | | -7.1 | | V |
| Gate resistance to COMx | | | 4.7 | | kΩ |
| Electrical Isolation | Remarks | Min | Тур | Max | Unit |
| Test voltage (50Hz/1s) | Primary to secondary side (Note 16) | 3800 | 3850 | 3900 | V _{eff} |
| | Secondary to secondary side (Note 16) | 3800 | 3850 | 3900 | V_{eff} |
| Partial discharge extinction volt. | Primary to secondary side (Note 17) | 1220 | | | V_{peak} |
| | Secondary to secondary side (Note 17) | 1200 | | | Vpeak |
| Creepage distance | Primary to secondary side | 12.6 | | | mm |
| | Secondary to secondary side | 6.6 | | | mm |
| | Primary to NTC | 6.5 | | | mm |
| Clearance distance | Primary to secondary side | 12.3 | | | mm |
| | Secondary to secondary side | 6.6 | | | mm |
| | Primary to NTC | 6.5 | | | mm |

All data refer to $+25^{\circ}$ C and V_{CC} = 15V unless otherwise specified



Footnotes to the Key Data

- 1) The gate current is limited by the gate resistors located on the driver.
- 2) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload.
- 3) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload. From 70°C to 85°C, the maximum permissible output power can be linearly interpolated from the given data.
- 4) This limit is due to active clamping. Refer to the "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers".
- 5) Undervoltage monitoring of the primary-side supply voltage (VCC to GND). If the voltage drops below this limit, a fault is transmitted to the corresponding outputs and the IGBTs are switched off.
- 6) Undervoltage monitoring of the secondary-side supply voltage (Visox to Veex and Veex to COMx which correspond with the approximate turn-on and turn-off gate-emitter voltages). If the corresponding voltage drops below this limit, the IGBT is switched off and a fault is transmitted to the corresponding output.
- 7) The input impedance can be modified to values $<18 \text{ k}\Omega$ (customer-specific solution).
- 8) Turn-on and turn-off threshold values can be increased (customer-specific solution).
- 9) The resulting pulse width of the direct output of the gate drive unit for short-circuit type I (excluding the delay of the gate resistors) is the sum of response time plus delay to IGBT turn-off.
- 10) The turn-off event of the IGBT is delayed by the specified time after the response time.
- 11) Factory set value. The blocking time can be reduced with an external resistor. Refer to the "Description & Application Manual for 2SP0115T SCALE-2 IGBT Drivers".
- 12) Measured from the transition of the turn-on or turn-off command at the driver input to direct output of the gate drive unit (excluding the delay of the gate resistors).
- 13) Output rise and fall times are measured between 10% and 90% of the nominal output swing with an output load of 10Ω and 40nF. The values are given for the driver side of the gate resistors. The time constant of the output load in conjunction with the present gate resistors leads to an additional delay at the load side of the gate resistors.
- 14) Transmission delay of the fault state from the secondary side to the primary status outputs.
- 15) The gate resistors can be leaded or surface mounted. Power Integrations reserves the right to determine which type will be used. Typically, higher quantities will be produced with SMD resistors and small quantities with leaded resistors.
- 16) HiPot testing (= dielectric testing) must generally be restricted to suitable components. This gate driver is suited for HiPot testing. Nevertheless, it is strongly recommended to limit the testing time to 1s slots as stipulated by EN 50178. Excessive HiPot testing at voltages much higher than $850V_{AC(eff)}$ may lead to insulation degradation. No degradation has been observed over 1min. testing at $3800V_{AC(eff)}$. The transformer of every production sample shipped to customers has undergone 100% testing at the given value or higher (< $5100V_{AC(eff)}$) for 1s.
- 17) Partial discharge measurement is performed in accordance with IEC 60270 and isolation coordination specified in EN 50178. The partial discharge extinction voltage between primary and either secondary side is coordinated for safe isolation to EN 50178.
- 18) Jitter measurements are performed with input signals INx switching between 0V and 15V referred to GND, with a corresponding rise time and fall time of 8ns.
- 19) Note that the dead time may vary from sample to sample. A tolerance of approximately ±20% may be expected. If higher timing precisions are required, Power Integrations recommends using direct mode and generating the dead time externally.
- 20) The storage temperature inside the original package (1) or in case the coating material of coated products may touch external parts (2) must be limited to the given value. Otherwise, it is limited to 90°C.
- 21) The component surface temperature, which may strongly vary depending on the operating condition, must be limited to the given value for coated driver versions to ensure long-term reliability of the coating material.



Legal Disclaimer

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Ordering Information

Our international terms and conditions of sale apply.

| Power Integrations Driver Type # | Related IGBT | |
|---|----------------------------|--|
| 2SP0115T2B0-FF450R12ME4 (Temperature range –40°C85°C) 2SP0115T2B0C-FF450R12ME4 (Temperature range –40°C85°C, conformal coating) | FF450R12ME4 FF450R12ME4 | |
| Product home page: <u>www.power.com/gate-driver/go/2SP0115T</u> | | |

Refer to <u>www.power.com/gate-driver/go/nomenclature</u> for information on driver nomenclature

Information about Other Products

For other drivers, evaluation systems product documentation and application support

Please click: www.power.com

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